

FMH35N60S1FD

FUJI POWER MOSFET

Super J MOS® S1 series

N-Channel enhancement mode power MOSFET

■ Features

Low on-state resistance Low switching loss easy to use (more controllabe switching dV/dt by Rg)

■ Applications

UPS

Server

Telecom

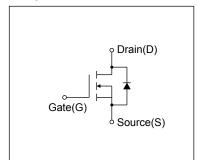
Power conditioner system

Power supply

■ Outline Drawings [mm]

TO-3P(Q)

■ Equivalent circuit schematic



■ Absolute Maximum Ratings at T_c=25°C (unless otherwise specified)

Description	Symbol	Characteristics	Unit	Remarks
Drain Source Voltage	V _{DS}	600	V	
Drain-Source Voltage	V _{DSX}	600	V	V _{GS} =-30V
Continuous Drain Current		A35	Α	Tc=25°C Note*1
Continuous Drain Current	lo RS	1000年22月日	Α	Tc=100°C Note*1
Pulsed Drain Current	lop/	±1,0\$ 1	A	Note*1
Gate-Source Voltage	VGS	(±30)	V	
Repetitive and Non-Repetitive Maximum Avalanche Current	TAR	alrect	А	Note *2
Non-Repetitive Maximum Avalanche Energy	Thice IPI	1239,6	す。 mJ	Note *3
Maximum Drain-Source dV/dt	dVos/dt	意息、50	kV/μs	V _{DS} ≤ 600V
Peak Diode Recovery dV/dt	dV/dt to Va	igning ₈₀	kV/μs	Note *4
Peak Diode Recovery -di/dt	Faildt - ON OF-	100	A/µs	Note *5
THRET THE	W tol	2.5	W	Ta=25°C
注: 新加加 not use the	FD	270	VV	Tc=25°C
Maximum Power Dissipation 注:新規設計には、 Operating and Storage Temperature range	Tch	150	°C	
	Tstg	-55 to +150	°C	

Note *1 : Limited by maximum channel temperature.

■ Electrical Characteristics at T_c=25°C (unless otherwise specified)

Static Ratings

Description	Symbol	Conditions		min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	BV _{DSS}	I _D =250μA V _{GS} =0V		600	-	-	V
Gate Threshold Voltage	V _{GS(th)}	I _D =1.3mA V _{DS} =V _{GS}		3.0	4.0	5.0	V
Zero Gate Voltage Drain Current	loss	V _{DS} =600V V _{GS} =0V	T _{ch} =25°C	-	-	25	- μΑ
		V _{DS} =480V V _{GS} =0V	T _{ch} =125°C	-	190	-	
Gate-Source Leakage Current	Igss	V _{GS} = ± 30V V _{DS} =0V		-	10	100	nA
Drain-Source On-State Resistance	R _{DS(on)}	I _D =17.5A V _{GS} =10V		-	0.089	0.105	Ω
Gate resistance	Rg	f=1MHz, open drain		-	1.1	-	Ω

Note *1: Limited by maximum channel temperature.

Note *2: Tch≤150°C, See Fig.1 and Fig.2

Note *3: Starting Tcn=25°C, Ias=4A, L=142mH, Vob=60V, Re=50Ω, See Fig.1 and Fig.2

Eas limited by maximum channel temperature and avalanche current.

Note *4: Ir≤-Ip, -di/dt=100A/µs, Vospeak≤600V, Tch≤150°C.

Note *5: Ir≤-Ip, dV/dt=30kV/µs, Vospeak≤600V, Tch≤150°C.

Dynamic Ratings

Description	Symbol	Conditions	min.	typ.	max.	Unit
Forward Transconductance	g _{fs}	I _D =17.5A V _{DS} =25V	13.5	27	-	S
Input Capacitance	Ciss	V _{DS} =400V	-	2530	-	
Output Capacitance	Coss	V _{GS} =0V	-	75	-	
Reverse Transfer Capacitance	Crss	f=250kHz	-	5.5	-	
Effective output capacitance, energy related (Note *6)	C _{o(er)}	V _{GS} =0V V _{DS} =0400V	-	195	-	pF
Effective output capacitance, time related (Note *7)	C _{o(tr)}	V _{GS} =0V V _{DS} =0400V ID=constant	-	670	-	
Turn On Time	t _{d(on)}	$\begin{array}{c} V_{\text{DD}}\text{=-}400\text{V, }V_{\text{GS}}\text{=-}10\text{V} \\ I_{\text{D}}\text{=-}17.5\text{A, }R_{\text{G}}\text{=-}18\Omega \\ \text{See Fig.3 and Fig.4} \end{array}$	-	116	-	ns
Turn-On Time	tr		-	28	-	
Turn-Off Time	t _{d(off)}		-	163	-	
	t f		-	18	-	
Total Gate Charge	Q _G	V _{DD} =400V, I _D =35A V _{GS} =10V See Fig.5	-	92	-	
Gate-Source Charge	Q _{GS}		-	24.5	-	nC
Gate-Drain Charge	Q _{GD}		-	38	-	IIC IIC
Drain-Source crossover Charge	Qsw		-	13	-	

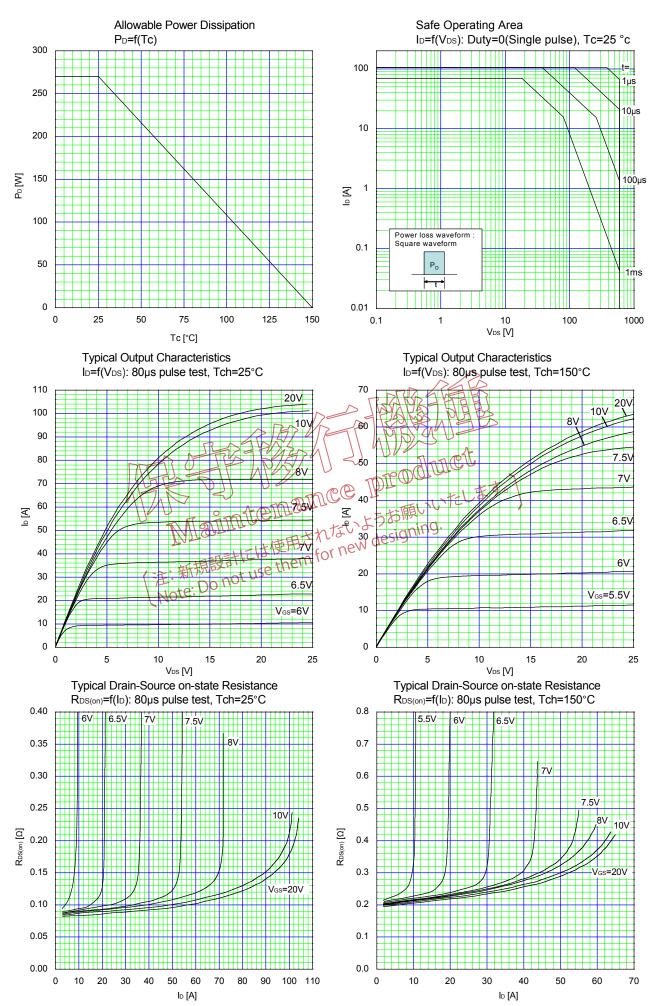
Note $^{\star}6$: $C_{O(er)}$ is a fixed capacitance that gives the same stored energy as C_{OSS} while V_{DS} is rising from 0 to 400V. Note $^{\star}7$: $C_{O(tr)}$ is a fixed capacitance that gives the same charging times as C_{OSS} while V_{DS} is rising from 0 to 400V.

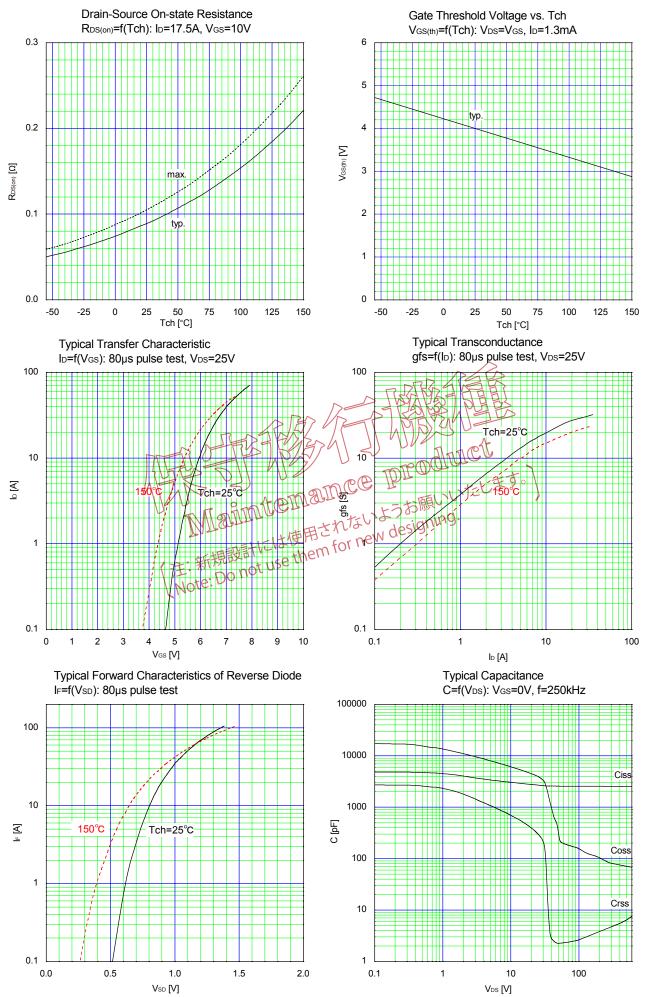
• Reverse Diode

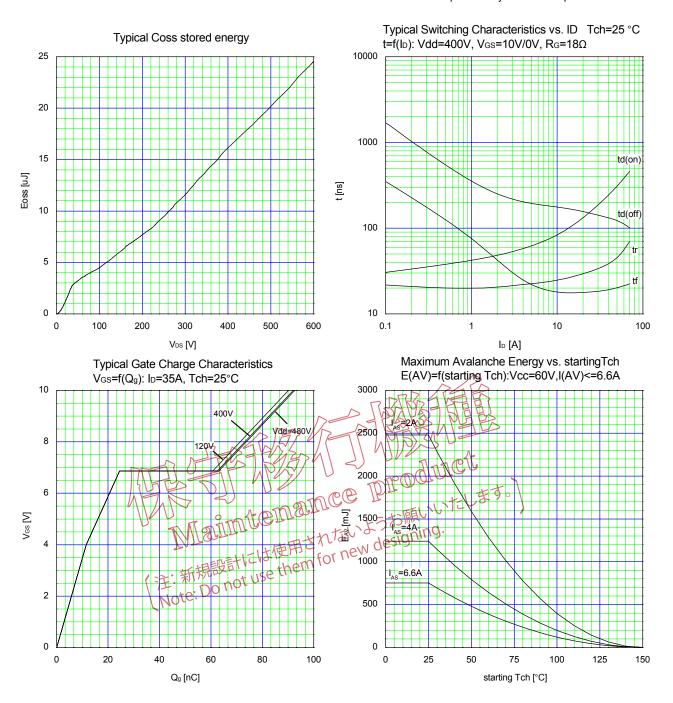
Reverse Diode		D-DTR	的偏昏	?		
Description	Symbol	Conditions	2 min 1	typ.	max.	Unit
Avalanche Capability	lav R	L=31.6mH, To-25°C See Fig. 1 and/Fig.2.	6.6	-	-	Α
Diode Forward On-Voltage	TVsp 5	II=35A,Wc6=0V) Tch=25°C	divice	t. \	1.35	V
Reverse Recovery Time		11-35-4 Von=400V	UNITED O	185	-	ns
Reverse Recovery Charge	O NI ar	-di/dt=100A/us 日本九年 design	- 1103-	1.3		μC
Peak Reverse Recovery Current	泄. 新規部	Th=25°CU Th=25°	-	14	-	Α
	Note: Do					

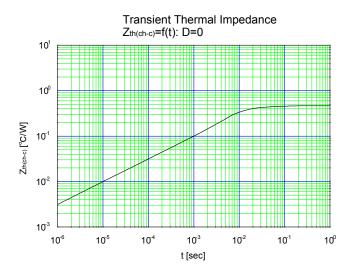
■ Thermal Resistance

Parameter	Symbol	min.	typ.	max.	Unit
Channel to Case	R _{th(ch-c)}	-	-	0.46	°C/W
Channel to Ambient	R _{th(ch-a)}	-	-	50	°C/W









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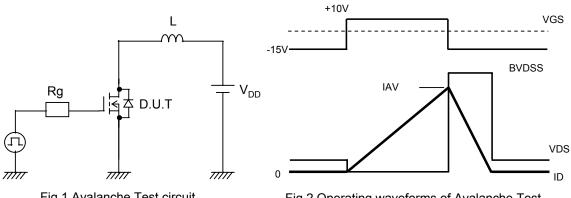


Fig.1 Avalanche Test circuit

Fig.2 Operating waveforms of Avalanche Test

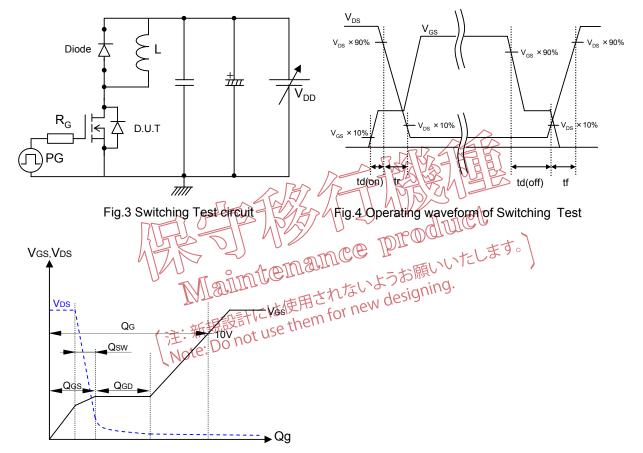


Fig.5 Operating waveform of Gate charge Test

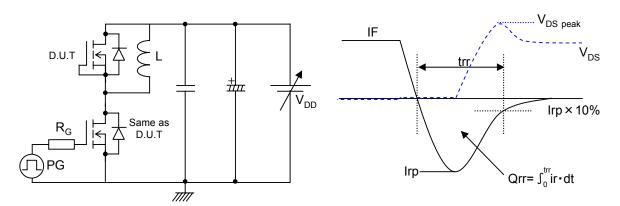
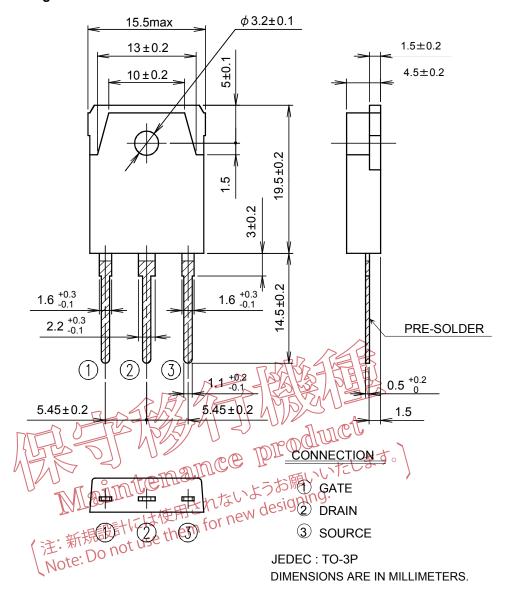


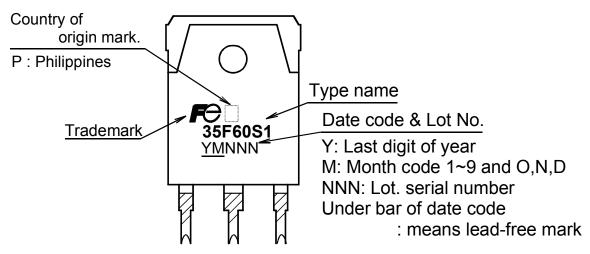
Fig.6 Reverse recovery Test circuit

Fig.7 Operating waveform of Reverse recovery Test

■ Outview: TO-3P(Q) Package



■ Marking



^{*} The font (font type,size) and the trademark-size might be actually different.

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